12/20/04

PCT/US 04/43077 DT03 Rec'd PCT/PT0 2 0 DEC 2004

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FORM PTO-1594 (Rev. 5-93)	1 01-	12-2005	U.S. DEPARTMENT OF COMMERCE
Atty Docket #: ONS00619F2	1 .		Patent and Trademark Office
To the Honorable Comm	issioner of Patents and Trademan 102	2918691 or copy thereof	
1. Name of convey		2. Name and address of receiving par	
Francis J. Carney		SEMICONDUCTOR COMPONENTS INDUSTRIES, L.L.C. of	
Michael J. Seddon		5005 East McDowell Road, Phoenix, A	AZ 85018
Kent L. Kime	_		
Dluong Ngan Leong Yeu Wen Lee			
Additional name(s) of conveying party(ies) is provided on attached sheet.			
3. Nature of convey	yance:		
Assignment	☐ Merger		
Security Agree	ement		
Other			
		1	
Execution date of	December 14, 2004; December 9,	Additional name(s) & address(es) attached?	∐ Yes ⊠ No
conveyance:	2004; December 9, 2004; December 10, 2004; and December		
	10, 2004; respectively.		
4. Application num	ber(s) or patent number(s):		
If this document is l	peing filed together with a new applica	tion, the execution date of the Dece	ember 14, 2004; December 9,
application is:		2	2004; December 9, 2004;
			December 10, 2004; and ember 10, 2004; respectively.
A Botont Applicati	on No (a):	<u> </u>	moer 10, 2004; respectively.
A. Patent Application No.(s):		B. Patent No.(s):	
1/2005 LLAMDGRA 00000 06	41. 22. 1. 100.11		
3:8081 40.00 DA	· · · · · · · · · · · · · · · · · · ·		
		imbers attached? Yes	No No
	s of party to whom correspondence nt should be mailed:	6. Total number of applications and patents involved:	
Name: SEMICONDUCTOR COMPONENTS INDUSTRIES, L.L.C.		7. Total fee (37 C.F.R. 3.41)	
	Patent Administration – A700	☐ Enclosed	
Street Address:	P. O. Box 62890	Authorized to be charged to deposit	account
City, State, Zip:	Phoenix, Arizona 85082-2890	8. Deposit account number: 501086	
	DO NO	T USE THIS SPACE	
9. Statement and sig			1,1,
To the best of my k	nowledge and belief, the foregoing inf	ormation is true and correct and any attac	ched copy is a true copy of
the original docume	on.	Henres Jules	1
Kevin B. Jackson	38,502	puris giren	12/15/04
Name of Person Signi	ng Reg. No.	Signature	Date
	Total number of pages including	cover sheet, attachments, and documen	ıt: 6

OMB No. 0651-0011 (exp. 4/94)

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

Name of (City/State/Country)

Francis J. Carney Gilbert, Arizona, USA;
Michael J. Seddon GILBERT, ARIZONA, USA;
Kent L. Kime Phoenix, Arizona, USA;

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States of America in and to certain inventions relating to improvements in SEMICONDUCTOR PACKAGE STRUCTURE HAVING ENHANCED THERMAL DISSIPATION (Attorney Docket No. ONSO0619F2), described, illustrated, and claimed in an application for Letters Patent filed in the United States under the Patent Cooperation Treaty executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

PATENT REEL: 016132 FRAME: 0912 We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

Francis J. Carney

Michael J Seddon

Mickael J. Seddon

Kent L. Kime

STATE OF ARIZONA

ss.:

COUNTY OF MARICOPA

I, Lydia McNamara, a Notary Public in and for the County and State aforesaid, do hereby certify that Michael J. Seddon, *Kenth.Kime whose name(s) are subscribed to the foregoing instrument, appeared before me this day in person and acknowledged that they/he/she signed, sealed and delivered the instrument as their/his/her free and voluntary act and deed for the uses and purposes therein set forth.

Given under my hand and notarial seal this 9th day of December, 2004

2004.

My commission expires on: July 30, 2006

Notary Public State of Anzona Maricopa County Lydia McNamara Expires July 30 2008 STATE OF ARIZONA ss.: COUNTY OF MARICOPA I, Lydia McNamara, a Notary Public in and for the County and State aforesaid, do hereby certify that whose name(s) are subscribed to the foregoing instrument, appeared

before me this day in person and acknowledged that they/he/she signed, sealed and delivered the instrument as their/his/her free and voluntary act and deed for the uses and purposes therein set forth.

Given under my hand and notarial seal this _____ day of December, 2004.

Commission expires on: July 30, 2006

Notary Public State of Arizona Ma∺copa County Lygia McNamara Expires July 30 2006

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Name of (City/State/Country)

Dluong Ngan Leong Yeu Wen Lee Seremban, MALAYSIA, Seremban, MALAYSIA

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States of America in and to certain inventions relating to improvements in SEMICONDUCTOR PACKAGE STRUCTURE HAVING ENHANCED THERMAL DISSIPATION (Attorney Docket No. ONSO0619F2), described, illustrated, and claimed in an application for Letters Patent filed in the United States under the Patent Cooperation Treaty executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

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Signed and Witnessed on (date):	By (inventor signature):	
10 DEC 2004	<u> 206</u>	
	Dluong Ngan Leong	
	······································	
Witness by (signature):	Printed Name of Witness:	
luyCr	CHIN WEE YONG	
Signed and Witnessed on (date):	By (inventor signature):	
10 DEC 2004	Yeu Wen Lee	
·////		
Witness by (signature):	Printed Name of Witness:	
_ wy	CHIN WEE YONG	

RECORDED: 12/20/2004

PATENT REEL: 016132 FRAME: 0916